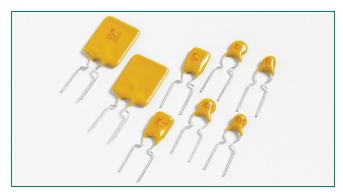


#### **USBR Series** RoHS P







# **Agency Approvals**

AGENCY	AGENCY FILE NUMBER
c <b>SU</b> °us	E183209
<b>△</b> TÜV	R50119318

### **Description**

• The USBR Series radial leaded device is designed to provide overcurrent protection for USB applications where space is not a concern.

### **Features**

- RoHS compliant and lead-free
- Fast time-to-trip
- Meets all USB protection requirements
- 40A short circuit rating
- Operating voltages of 6-16V

### **Applications**

- Computers & peripherals
- Any USB application

#### **Electrical Characteristics**

Part Number	<sub>hold</sub>	l trip	V <sub>max</sub>	l <sub>max</sub>	P <sub>d</sub>	Maximum Time To Trip		Resistance		Agency Approvals	
Fait Nuilibei	(A)	(A)	(Vdc)	(A)	max. (W)	Current (A)	Time (Sec.)	R <sub>min</sub> (Ω)	R <sub>1max</sub> (Ω)	c <b>SV</b> us	Д TÜV
06R075B	0.75	1.30	6	40	0.3	8.00	0.4	0.100	0.230	Х	Χ
06R120B	1.20	2.00	6	40	0.6	8.00	0.5	0.065	0.140	Х	Х
06R155B	1.55	2.70	6	40	0.6	7.75	2.2	0.040	0.100	Х	X
16R090B	0.90	1.80	16	40	0.6	8.00	1.2	0.070	0.180	Х	Х
16R110B	1.10	2.20	16	40	0.7	8.00	2.3	0.050	0.140	Х	Х
16R135B	1.35	2.70	16	40	0.8	8.00	4.5	0.040	0.120	X	Χ
16R160B	1.60	3.20	16	40	0.9	8.00	9.0	0.030	0.110	X	Χ
16R185B	1.85	3.70	16	40	1.0	8.00	10.0	0.030	0.090	Х	Х
16R250B	2.50	5.00	16	40	1.2	8.00	40.0	0.020	0.060	Х	Х

I bold = Hold current: maximum current device will pass without tripping in 20°C still air.

Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.

I  $_{\mathrm{trip}}$  = Trip current: minimum current at which the device will trip in 20°C still air.

 $V_{\max}$  = Maximum voltage device can withstand without damage at rated current (I max)  $I_{max}$  = Maximum fault current device can withstand without damage at rated voltage  $(V_{max})$ 

P<sub>d</sub> = Power dissipated from device when in the tripped state at 20°C still air.

R min = Minimum resistance of device in initial (un-soldered) state.

R  $_{\rm typ}$  = Typical resistance of device in initial (un-soldered) state.

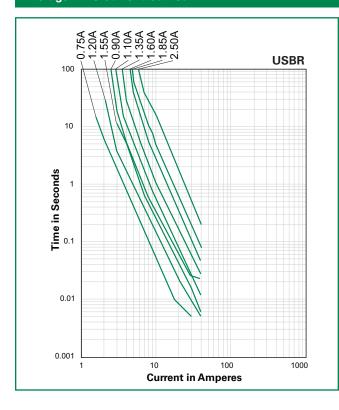
R  $_{\mathrm{1max}}$  = Maximum resistance of device at 20°C measured one hour after tripping or reflow soldering of 260°C for 20 sec.



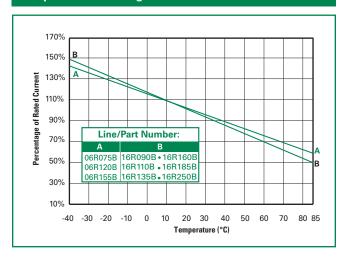
### **Temperature Rerating**

	Ambient Operation Temperature									
	-40°C	-20°C	0°C	23°C	40°C	50°C	60°C	70°C	85°C	
Part Number				Н	old Current (	A)				
06R075B	1.05	0.95	0.85	0.75	0.65	0.60	0.55	0.50	0.43	
06R120B	1.69	1.52	1.36	1.20	1.04	0.96	0.88	0.80	0.68	
06R155B	2.17	1.96	1.75	1.55	1.34	1.24	1.13	1.03	0.88	
16R090B	1.31	1.17	1.04	0.90	0.75	0.69	0.61	0.55	0.47	
16R110B	1.60	1.43	1.27	1.10	1.00	0.92	0.75	0.67	0.57	
16R135B	1.96	1.76	1.55	1.35	1.12	1.04	0.92	0.82	0.70	
16R160B	2.32	2.08	1.84	1.60	1.33	1.23	1.09	0.98	0.83	
16R185B	2.68	2.41	2.13	1.85	1.54	1.42	1.26	1.13	0.96	
16R250B	3.63	3.25	2.88	2.50	2.08	1.93	1.70	1.53	1.30	

### **Average Time Current Curves**

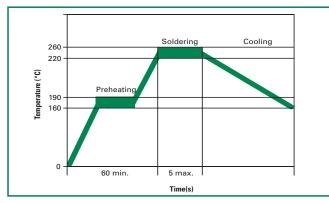


### **Temperature Rerating Curve**



The average time current curves and Temperature Rerating curve performance is affected by a number or variables, and these curves provided as guidance only. Customer must verify the performance in their application.

### **Soldering Parameters**



Pre-Heating Zone	Refer to the condition recommended by the flux manufacturer. Max. ramping rate should not exceed 4°C/Sec.
Soldering Zon	Max. solder temperature should not exceed 260°C
Cooling Zone	Cooling by natural convection in air.

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### **Physical Specifications**

Lead Material	.90-2.50A: Tin-plated Copper clad steel .75A: Tin-plated Copper
Soldering Characteristics	Solderability per MIL-STD-202, Method 208E
Insulating Material	Cured, flame retardant epoxy polymer meets UL 94V-0 requirements.
Device Labeling	Marked with 'LF', voltage, current rating, and date code.

### **Environmental Specifications**

Operating/Storage Temperature	-40°C to +85°C
Maximum Device Surface Temperature in Tripped State	125°C
Passive Aging	+85°C, 1000 hours -/+5% typical resistance change
Humidity Aging	+85°C, 85% R.H., 1000 hours -/+5% typical resistance change
Thermal Shock	+85°C to -40°C 10 times -/+5% typical resistance change
Solvent Resistance	MIL-STD-202, Method 215F
Moisture Sensivitivy Level	Level 1, J-STD-020C

### **Dimensions (mm)**

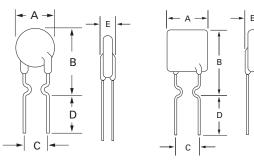
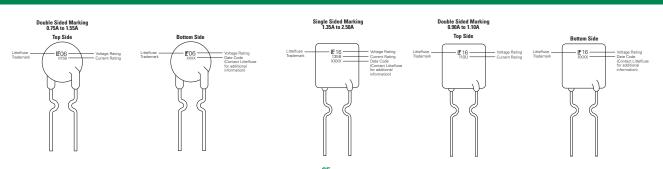


Figure 1

Figure 2

		А		В		С		D		Е		Physic	al Char	acteristics
Part Number	Figure	Inches	mm	Lead	(dia)	Material								
Number		Max.	Max.	Max.	Max.	Тур.	Тур.	Min.	Min.	Max.	Max.	Inches	mm	Materiai
06R075B	1	0.27	6.9	0.45	11.4	0.20	5.1	0.30	7.6	0.12	3	0.020	0.51	Sn/Cu
06R120B	1	0.27	6.9	0.46	11.7	0.20	5.1	0.30	7.6	0.12	3	0.020	0.51	Sn/CuFe
06R155B	1	0.27	6.9	0.46	11.7	0.20	5.1	0.30	7.6	0.12	3	0.020	0.51	Sn/CuFe
16R090B	2	0.29	7.4	0.48	12.2	0.20	5.1	0.30	7.6	0.12	3	0.020	0.51	Sn/CuFe
16R110B	2	0.29	7.4	0.56	14.2	0.20	5.1	0.30	7.6	0.12	3	0.020	0.51	Sn/CuFe
16R135B	2	0.35	8.9	0.53	13.5	0.20	5.1	0.30	7.6	0.12	3	0.020	0.51	Sn/CuFe
16R160B	2	0.35	8.9	0.60	15.2	0.20	5.1	0.30	7.6	0.12	3	0.020	0.51	Sn/CuFe
16R185B	2	0.40	10.2	0.62	15.7	0.20	5.1	0.30	7.6	0.12	3	0.020	0.51	Sn/CuFe
16R250B	2	0.45	11.4	0.72	18.3	0.20	5.1	0.30	7.6	0.12	3	0.020	0.51	Sn/CuFe

### **Part Marking System**

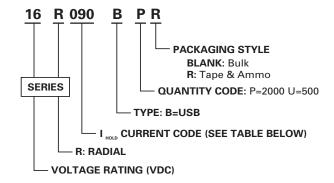


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USBR Series



### **Part Ordering Number System**



### **Ordering Information**

Part Number	Ordering Number	I <sub>hold</sub> (A)	I <sub>hold</sub> Code	Packaging Option	Quantity	Quantity & Packaging Codes
06R075B	06R075BU	0.75	075	Bulk	500	U
0000756	06R075BPR	0.75	0/5	Tape and Ammo	2000	PR
06R120B	06R120BU	1.20	120	Bulk	500	U
00h120b	06R120BPR	1.20	120	Tape and Ammo	2000	PR
06R155B	06R155BU	1.55 1.55		Bulk	500	U
0641998	06R155BPR	1.55	155	Tape and Ammo	2000	PR
16D000D	16R090BU	0.00	000	Bulk	500	U
16R090B	16R090BPR	0.90	090	Tape and Ammo	2000	PR
1001100	16R110BU	1 10	110	Bulk	500	U
16R110B	16R110BPR	1.10	110	Tape and Ammo	2000	PR
16R135B	16R135BU	1.05	105	Bulk	500	U
100 1300	16R135BPR	1.35	135	Tape and Ammo	2000	PR
16D160D	16R160BU	1.60	160	Bulk	500	U
16R160B	16R160BPR	1.60	160	Tape and Ammo	2000	PR
16R185B	16R185BU	1.85	105	Bulk	500	U
100 1800	16R185BPR	1.85	185	Tape and Ammo	2000	PR
1602500	16R250BU	2.50	250	Bulk	500	U
16R250B	16R250BPR	2.50	250	Tape and Ammo	2000	PR

### **Tape and Ammo Specifications**

Devices taped using EIA468-B/IE286-2 standards. See table below and Figure 1 for details.

evices taped using EIA468-B/IE286-2 stand	TOT GETAILS.  Dimensions			
Dimension	EIA Mark	IEC Mark	Dim. (mm)	Tol. (mm)
Carrier tape width	w	w	18	-0.5 / +1.0
Hold down tape width	W <sub>4</sub>	<b>W</b> <sub>o</sub>	11	min.
Top distance between tape edges	W <sub>6</sub>	$\mathbf{W}_{2}$	3	max.
Sprocket hole position	W <sub>5</sub>	W <sub>1</sub>	9	-0.5 / +0.75
Sprocket hole diameter*	<b>D</b> <sub>0</sub>	<b>D</b> <sub>o</sub>	4	-/+ 0.32
Abscissa to plane(straight lead)	н	н	18.5	-/+ 3.0
Abscissa to plane(kinked lead)	H <sub>o</sub>	H <sub>o</sub>	16	-/+ 0.5
Abscissa to top	H <sub>1</sub>	H <sub>1</sub>	32.2	max.
Overall width w/o lead protrusion	<b>C</b> <sub>1</sub>		42.5	max.
Overall width w/ lead protrusion	<b>C</b> <sub>2</sub>		43.2	max.
Lead protrusion	L,	I <sub>1</sub>	1.0	max.
Protrusion of cut out	L	L	11	max.
Protrusion beyond hold-down tape			Not specified	
Sprocket hole pitch	P <sub>o</sub>	P <sub>o</sub>	12.7	-/+ 0.35
Pitch tolerance			20 consecutive	-/+ 1
Device pitch			12.7	
Tape thickness	t	t	0.9	max.
Tape thickness with splice	t,		2.0	max.
Splice sprocket hole alignment			0	-/+ 0.3
Body lateral deviation	Δh	Δh	0	-/+ 1.0
Body tape plane deviation	Δр	Δр	0	-/+ 1.3
Ordinate to adjacent component lead*	<b>P</b> <sub>1</sub>	<b>P</b> <sub>1</sub>	3.81	-/+ 1.0
Lead spacing*	F	F	5.08	-/+ 0.8

<sup>\*</sup>Differs from EIA specification.

### **Tape and Ammo Diagram**

